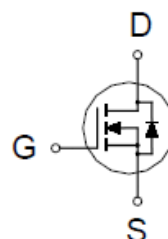
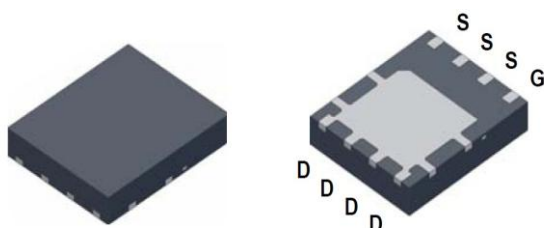


# P2E03BK

## N-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$               | $I_D$ |
|---------------|----------------------------|-------|
| 30V           | $2.5m\Omega @V_{GS} = 10V$ | 106A  |



PDFN 5\*6P

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |                                     | SYMBOL         | LIMITS     | UNITS              |
|------------------------------------------------|-------------------------------------|----------------|------------|--------------------|
| Drain-Source Voltage                           |                                     | $V_{DS}$       | 30         | V                  |
| Gate-Source Voltage                            |                                     | $V_{GS}$       | $\pm 20$   |                    |
| Continuous Drain Current <sup>3</sup>          | $T_C = 25\text{ }^{\circ}\text{C}$  | $I_D$          | 106        | A                  |
|                                                | $T_C = 100\text{ }^{\circ}\text{C}$ |                | 67         |                    |
| Pulsed Drain Current <sup>1</sup>              |                                     | $I_{DM}$       | 180        |                    |
| Continuous Drain Current                       | $T_A = 25\text{ }^{\circ}\text{C}$  | $I_D$          | 22         |                    |
|                                                | $T_A = 70\text{ }^{\circ}\text{C}$  |                | 18         |                    |
| Avalanche Current                              |                                     | $I_{AS}$       | 67         | mJ                 |
| Avalanche Energy                               | $L = 0.1mH$                         | $E_{AS}$       | 227        |                    |
| Power Dissipation                              | $T_C = 25\text{ }^{\circ}\text{C}$  | $P_D$          | 48         | W                  |
|                                                | $T_C = 100\text{ }^{\circ}\text{C}$ |                | 19         |                    |
| Power Dissipation                              | $T_A = 25\text{ }^{\circ}\text{C}$  | $P_D$          | 2.1        |                    |
|                                                | $T_A = 70\text{ }^{\circ}\text{C}$  |                | 1.4        |                    |
| Operating Junction & Storage Temperature Range |                                     | $T_J, T_{STG}$ | -55 to 150 | $^{\circ}\text{C}$ |

### THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE               |              | SYMBOL          | TYPICAL | MAXIMUM | UNIT                          |
|----------------------------------|--------------|-----------------|---------|---------|-------------------------------|
| Junction-to-Ambient <sup>2</sup> | Steady-State | $R_{\theta JA}$ |         | 57      | $^{\circ}\text{C} / \text{W}$ |
| Junction-to-Case                 | Steady-State | $R_{\theta JC}$ |         | 2.6     |                               |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz.Copper, in a still air environment with  $T_A=25^{\circ}\text{C}$ .The value in any given application depends on the user's specific board design

<sup>3</sup>Package limitation current is 78A

# P2E03BK

## N-Channel Enhancement Mode MOSFET

### ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

| PARAMETER                                                                      | SYMBOL        | TEST CONDITIONS                                                    | LIMITS |      |           | UNIT       |
|--------------------------------------------------------------------------------|---------------|--------------------------------------------------------------------|--------|------|-----------|------------|
|                                                                                |               |                                                                    | MIN    | TYP  | MAX       |            |
| STATIC                                                                         |               |                                                                    |        |      |           |            |
| Drain-Source Breakdown Voltage                                                 | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$                                      | 30     |      |           | V          |
| Gate Threshold Voltage                                                         | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu A$                                  | 1      | 1.6  | 3         |            |
| Gate-Body Leakage                                                              | $I_{GSS}$     | $V_{DS} = 0V, V_{GS} = \pm 20V$                                    |        |      | $\pm 100$ | nA         |
| Zero Gate Voltage Drain Current                                                | $I_{DSS}$     | $V_{DS} = 24V, V_{GS} = 0V$ ,                                      |        |      | 1         | $\mu A$    |
|                                                                                |               | $V_{DS} = 20V, V_{GS} = 0V, T_J = 55\text{ }^{\circ}C$             |        |      | 10        |            |
| Drain-Source On-State Resistance <sup>1</sup>                                  | $R_{DS(ON)}$  | $V_{GS} = 4.5V, I_D = 16A$                                         |        | 2.4  | 4         | m $\Omega$ |
|                                                                                |               | $V_{GS} = 10V, I_D = 20A$                                          |        | 1.6  | 2.5       |            |
| Forward Transconductance <sup>1</sup>                                          | $g_{fs}$      | $V_{DS} = 5V, I_D = 20A$                                           |        | 65   |           | S          |
| DYNAMIC                                                                        |               |                                                                    |        |      |           |            |
| Input Capacitance                                                              | $C_{iss}$     | $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$                              |        | 4610 |           | pF         |
| Output Capacitance                                                             | $C_{oss}$     |                                                                    |        | 850  |           |            |
| Reverse Transfer Capacitance                                                   | $C_{rss}$     |                                                                    |        | 634  |           |            |
| Gate Resistance                                                                | $R_g$         | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$                               |        | 1.1  |           | $\Omega$   |
| Total Gate Charge <sup>2</sup>                                                 | $Q_g$         | $V_{GS}=10V$                                                       |        | 107  |           | nC         |
|                                                                                |               | $V_{GS}=4.5V$                                                      |        | 54   |           |            |
| Gate-Source Charge <sup>2</sup>                                                | $Q_{gs}$      | $V_{DS} = 0.5V_{(BR)DSS}, I_D = 20A,$<br>$V_{GS} = 10V$            |        | 14   |           |            |
| Gate-Drain Charge <sup>2</sup>                                                 | $Q_{gd}$      |                                                                    |        | 26   |           |            |
| Turn-On Delay Time <sup>2</sup>                                                | $t_{d(on)}$   | $V_{DS} = 15V,$<br>$V_{GS} = 10V, I_D \cong 1A, R_{GEN} = 6\Omega$ |        | 20.4 |           | nS         |
| Rise Time <sup>2</sup>                                                         | $t_r$         |                                                                    |        | 8.1  |           |            |
| Turn-Off Delay Time <sup>2</sup>                                               | $t_{d(off)}$  |                                                                    |        | 113  |           |            |
| Fall Time <sup>2</sup>                                                         | $t_f$         |                                                                    |        | 15.7 |           |            |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_J = 25\text{ }^{\circ}C$ ) |               |                                                                    |        |      |           |            |
| Continuous Current <sup>3</sup>                                                | $I_S$         |                                                                    |        |      | 106       | A          |
| Forward Voltage <sup>1</sup>                                                   | $V_{SD}$      | $I_F = 20A, V_{GS} = 0V$                                           |        |      | 1         | V          |
| Reverse Recovery Time                                                          | $t_{rr}$      | $I_F = 20\text{ A}, dI_F/dt = 100A/\mu S$                          |        | 32   |           | nS         |
| Reverse Recovery Charge                                                        | $Q_{rr}$      |                                                                    |        | 18   |           | nC         |

<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

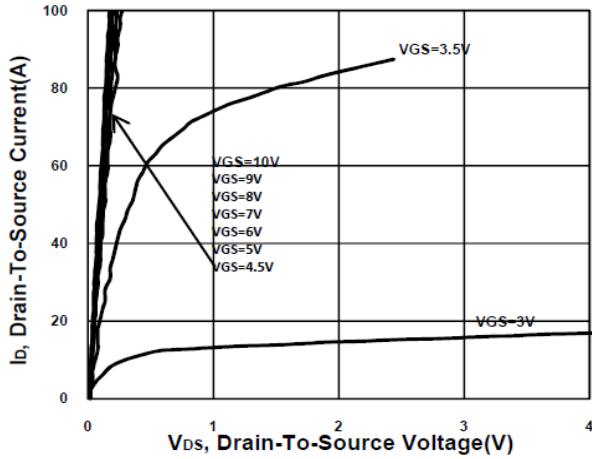
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Package limitation current is 78A

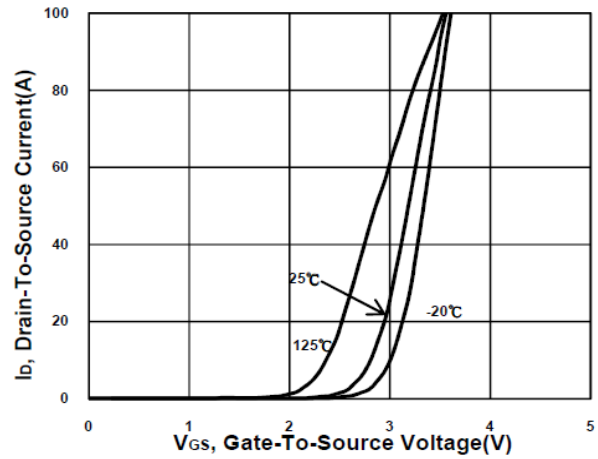
## P2E03BK

### N-Channel Enhancement Mode MOSFET

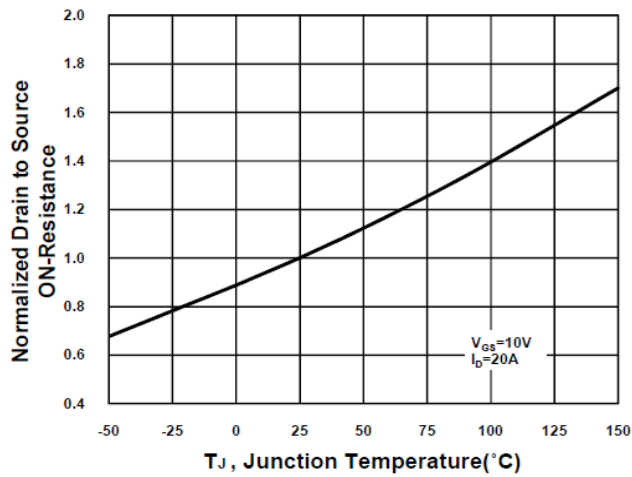
**Output Characteristics**



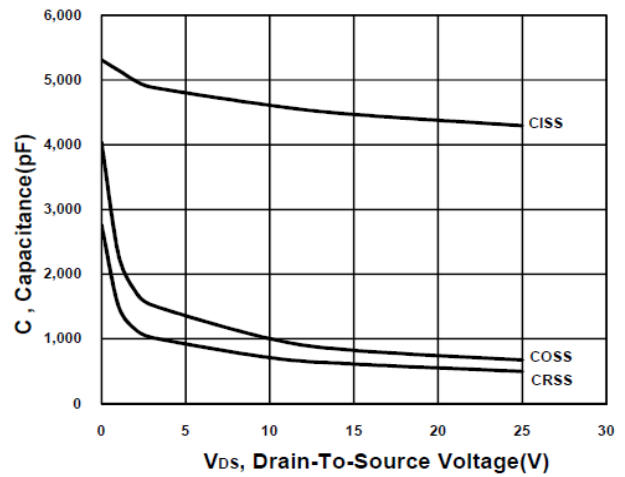
**Transfer Characteristics**



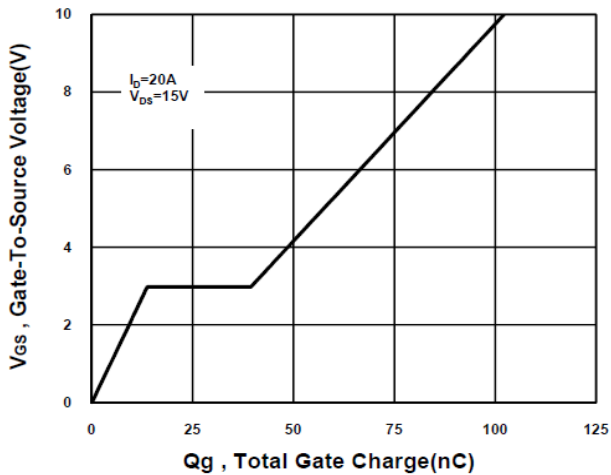
**On-Resistance VS Temperature**



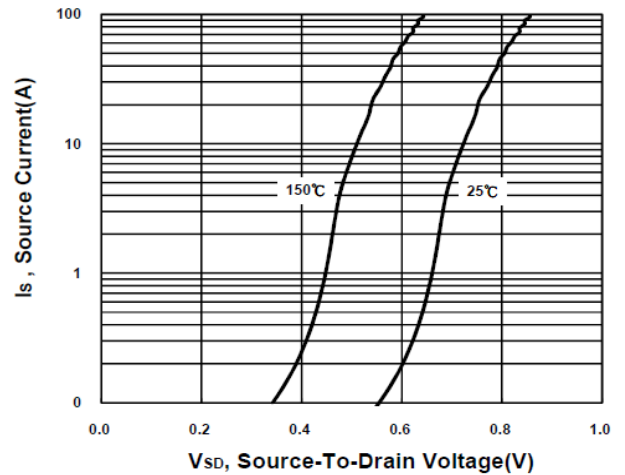
**Capacitance Characteristic**



**Gate charge Characteristics**



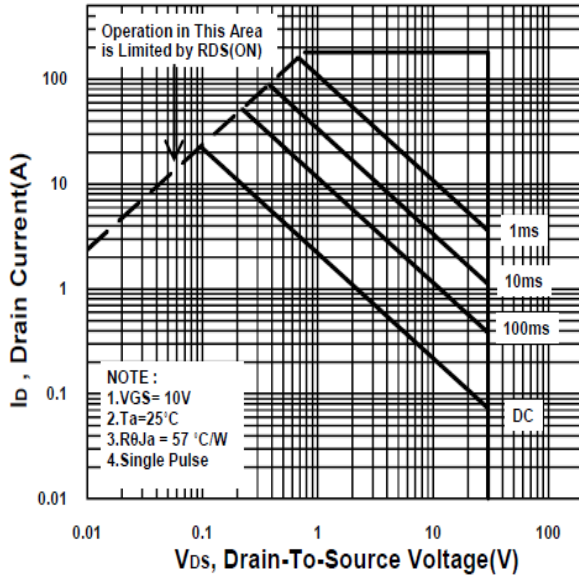
**Source-Drain Diode Forward Voltage**



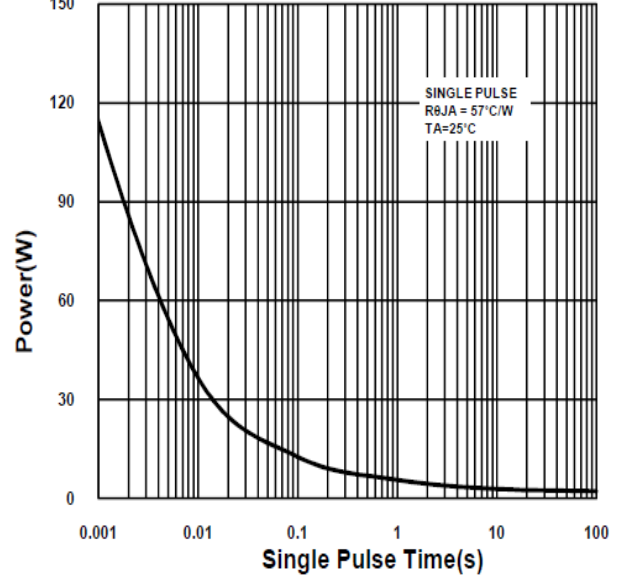
## P2E03BK

### N-Channel Enhancement Mode MOSFET

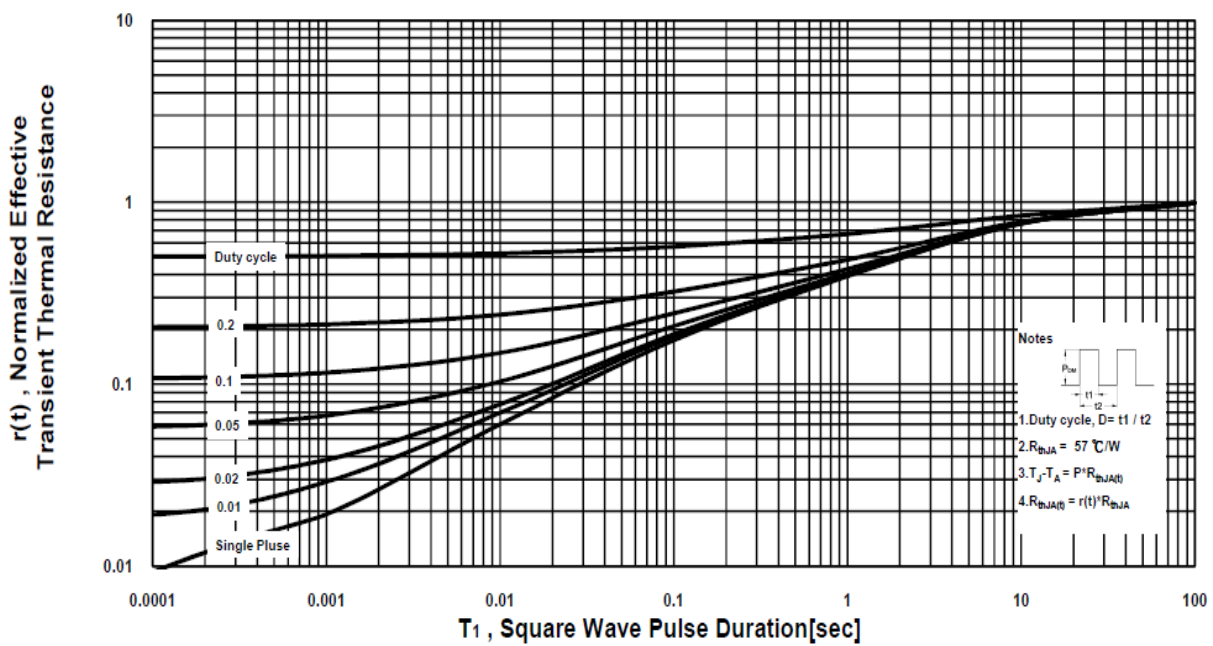
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**



## P2E03BK

### N-Channel Enhancement Mode MOSFET

#### Package Dimension

#### PDFN 5x6P MECHANICAL DATA

| Dimension | mm   |      |      | Dimension | mm   |      |       |
|-----------|------|------|------|-----------|------|------|-------|
|           | Min. | Typ. | Max. |           | Min. | Typ. | Max.  |
| A         | 4.8  |      | 5.15 | J         | 3.33 |      | 3.78  |
| B         | 5.44 |      | 5.9  | K         | 0.9  |      |       |
| C         | 5.9  |      | 6.35 | L         | 0.35 |      | 0.712 |
| D         | 0.33 |      | 0.51 | M         | 0°   |      | 12°   |
| E         |      | 1.27 |      | N         | 4.8  |      | 5.5   |
| F         | 0.8  |      | 1.25 | O         | 0.05 |      | 0.3   |
| G         | 0.15 |      | 0.34 | P         | 0.06 |      | 0.2   |
| H         | 3.61 |      | 4.31 | S         | 3.69 |      | 4.19  |
| I         | 0.35 |      | 0.71 |           |      |      |       |

